

MOSFET

OptiMOS[™] 5 Power-Transistor, 150 V

Features

- N-channel
- Superior thermal resistance
- 100% avalanche tested

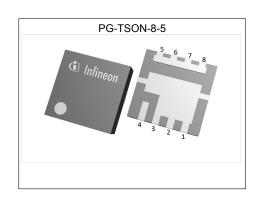
- Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21
 Optimized for high performance SMPS, e.g. syncronous rectification

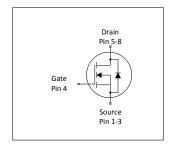
Product validation

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

Table 1 Rey 1 citorinance 1 arameters							
Parameter	Value	Unit					
V _{DS}	150	V					
R _{DS(on),max}	22	mΩ					
I _D	44	A					
Qoss	40	nC					
Q _G	14.4	nC					











Type / Ordering Code	Package	Marking	Related Links
IQE220N15NM5	PG-TSON-8-5	22015N5	-

OptiMOS[™] 5 Power-Transistor, 150 V



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1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

Danamatan	Cumb al		Value	s	11:4	Nata / Tank Oan distant
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - -	-	44 31 7	A	V_{GS} =10 V, T_{C} =25 °C V_{GS} =10 V, T_{C} =100 °C V_{GS} =10 V, T_{A} =25 °C, R_{thJA} =60 °C/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	176	Α	<i>T</i> _A =25 °C
Avalanche energy, single pulse ⁴⁾	E AS	-	-	40	mJ	I_D =20 A, R_{GS} =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	100 2.5	W	T _C =25 °C T _A =25 °C, R _{thJA} =60 °C/W ²⁾
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	IEC climatic category; DIN IEC 68-1: 55/175/56

2 Thermal characteristics

Table 3 Thermal characteristics

Daramatar	Symbol		Values		Unit	t Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Ullit	Note / Test Condition
Thermal resistance, junction - case, bottom	R _{thJC}	-	0.8	1.5	°C/W	-
Thermal resistance, junction - ambient, 6 cm² cooling area²)	R _{thJA}	-	-	60	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. $^{2)}$ Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information

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3 Electrical characteristics

at T_j=25 °C, unless otherwise specified

Table 4 Static characteristics

D	0	Values				N 4 7 4 0 100
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	150	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	V _{GS(th)}	3.0	3.8	4.6	V	V _{DS} =V _{GS} , I _D =46 μA
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1.0 100	μA	V _{DS} =120 V, V _{GS} =0 V, T _j =25 °C V _{DS} =120 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	1	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	17.2 19	22 35	mΩ	V _{GS} =10 V, I _D =16 A V _{GS} =8 V, I _D =8 A
Gate resistance ¹⁾	R _G	-	0.8	1.2	Ω	-
Transconductance	g fs	-	32	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 22 A$

Table 5 Dynamic characteristics

Parameter	Cumbal		Values		I I mid	Note / Took Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	Ciss	-	1100	1400	pF	V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz
Output capacitance ¹⁾	Coss	-	260	340	pF	V _{GS} =0 V, V _{DS} =75 V, f=1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	8	14	pF	V _{GS} =0 V, V _{DS} =75 V, f=1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	8.1	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =22 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	1.9	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =22 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{ m d(off)}$	-	8.2	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =22 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	2.1	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =22 A, $R_{\rm G,ext}$ =1.6 Ω

Table 6 Gate charge characteristics²⁾

Davamatar	Cymbal		Values	;	l lmi4	Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Gate to source charge	Q _{gs}	-	6.2	-	nC	V _{DD} =75 V, I _D =22 A, V _{GS} =0 to 10 V	
Gate charge at threshold	$Q_{g(th)}$	-	4.0	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =22 A, $V_{\rm GS}$ =0 to 10 V	
Gate to drain charge ¹⁾	$Q_{ m gd}$	-	3.1	4.7	nC	V_{DD} =75 V, I_{D} =22 A, V_{GS} =0 to 10 V	
Switching charge	Q _{sw}	-	5.3	-	nC	V _{DD} =75 V, I _D =22 A, V _{GS} =0 to 10 V	
Gate charge total ¹⁾	Qg	-	14.4	18	nC	V _{DD} =75 V, I _D =22 A, V _{GS} =0 to 10 V	
Gate plateau voltage	V _{plateau}	-	5.8	-	V	V _{DD} =75 V, I _D =22 A, V _{GS} =0 to 10 V	
Output charge ¹⁾	Qoss	-	40	53	nC	V _{DS} =75 V, V _{GS} =0 V	

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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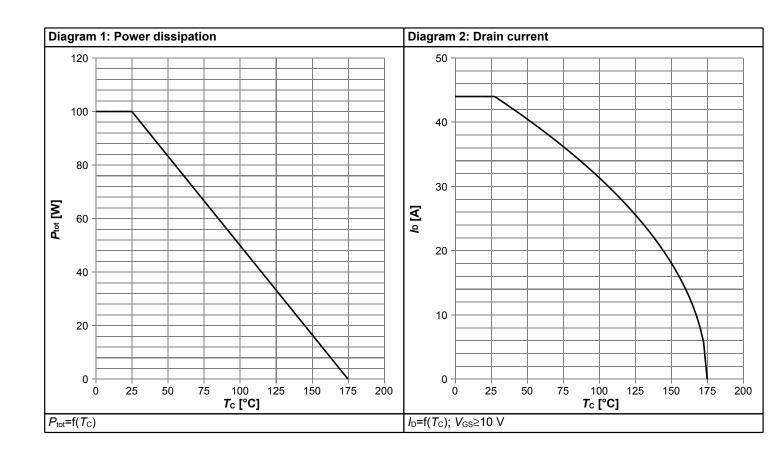


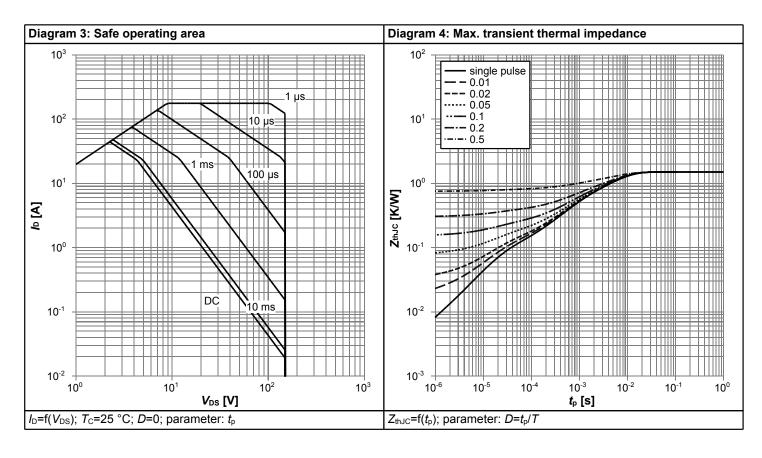
Table 7 Reverse diode

Damamatan	Cymphol		Values	;	Unit	Nata / Taat Canditian	
Parameter	Symbol	Min.	Тур.	Max.		Note / Test Condition	
Diode continuous forward current	Is	-	-	44	Α	T _C =25 °C	
Diode pulse current	I _{S,pulse}	-	-	176	Α	<i>T</i> _C =25 °C	
Diode forward voltage	V _{SD}	-	0.86	1.2	V	V _{GS} =0 V, I _F =22 A, T _j =25 °C	
Reverse recovery time ¹⁾	<i>t</i> _{rr}	-	25	50	ns	V _R =75 V, I _F =22 A, d <i>i</i> _F /d <i>t</i> =100 A/μs	
Reverse recovery charge ¹⁾	Q _{rr}	-	17	34	nC	V _R =75 V, I _F =22 A, d <i>i</i> _F /d <i>t</i> =100 A/μs	

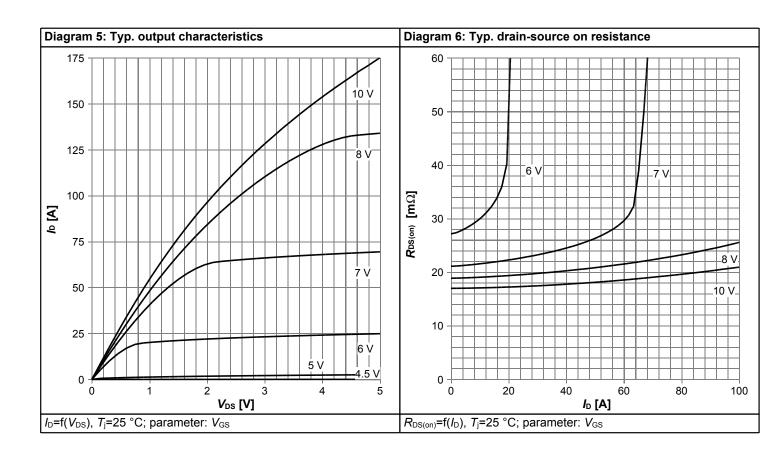


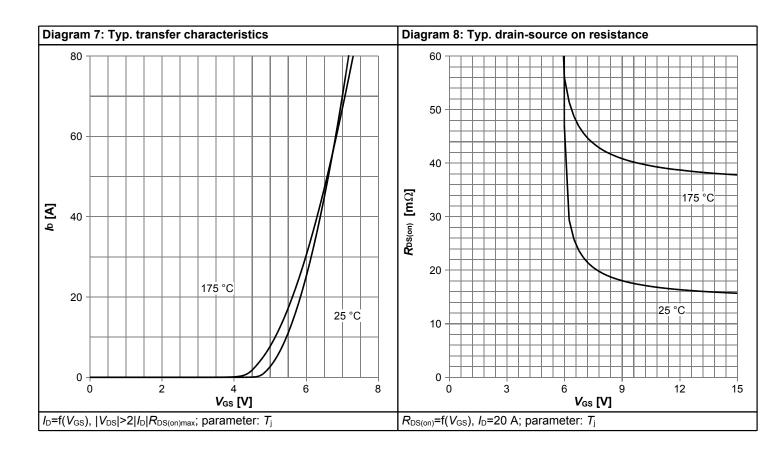
4 Electrical characteristics diagrams



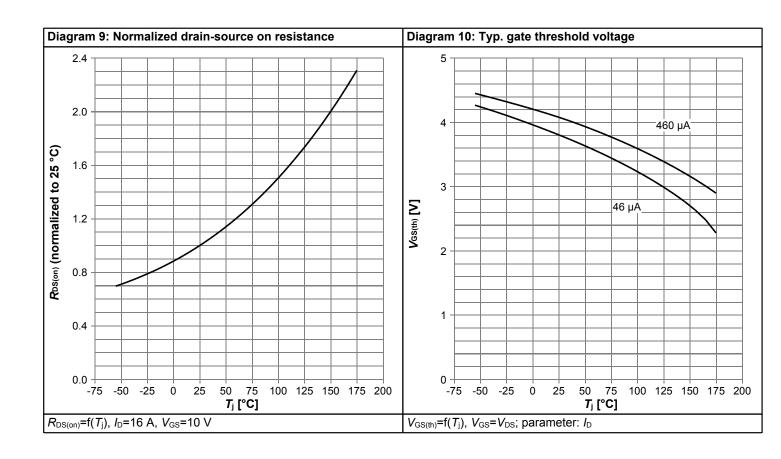


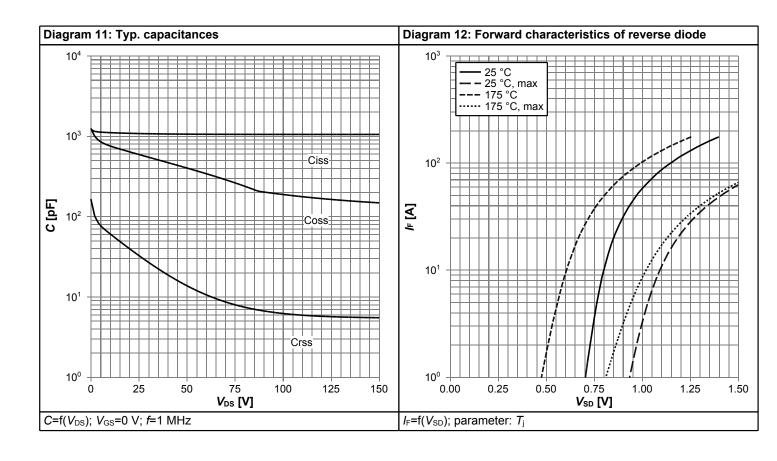




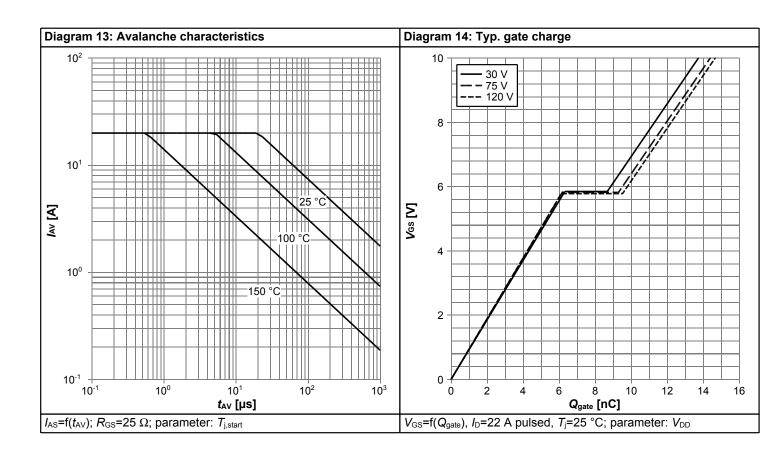


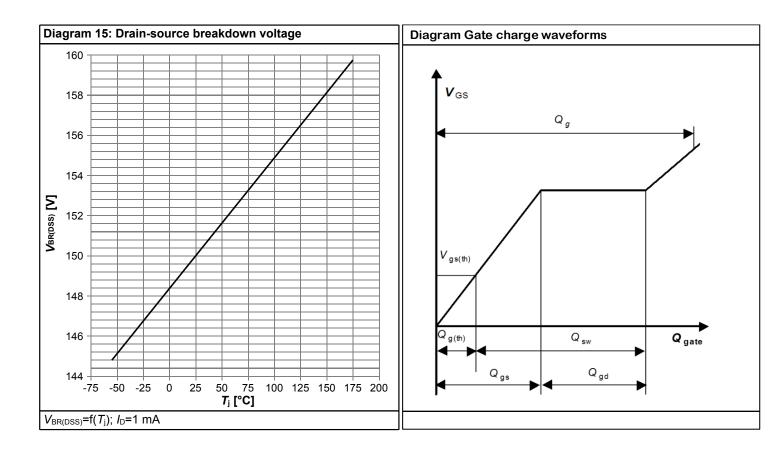






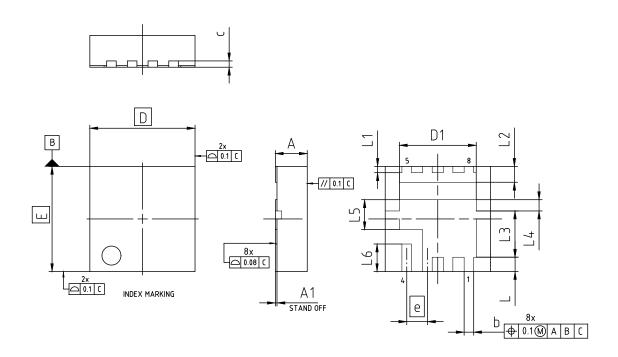








5 Package Outlines



DIMENSION	MILLIMETERS					
DIMENSION	MIN.	MAX.				
Α	-	1.10				
A1	-	0.05				
b	0.20	0.40				
С	0.:	20				
D	3.	30				
D1	2.31	2.51				
E	3.30					
е	0.65					
L	0.35	0.55				
L1	0.10	0.30				
L2	0.40	0.60				
L3	1.35	1.55				
L4	0.26	0.46				
L5	0.84	1.04				
L6	0.77	0.97				

DOCUMENT NO. Z8B00198723		
REVISION 01		
SCALE 10:1		
0 1 2mm		
EUROPEAN PROJECTION		
ISSUE DATE 06.11.2019		

Figure 1 Outline PG-TSON-8-5, dimensions in mm

OptiMOS[™] 5 Power-Transistor, 150 V



Revision History

IQE220N15NM5

Revision: 2022-06-03, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2022-06-03	Release of final version

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